

NGTB15N60R2FG

IGBT 600V, 14A, N-Channel



ON Semiconductor®

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Features

- Reverse Conducting II IGBT
- IGBT $V_{CE(sat)}=1.85V$ typ. ($I_C=15A$, $V_{GE}=15V$)
- IGBT $t_f=75ns$ typ.
- Diode $V_F=1.7V$ typ. ($I_F=15A$)
- Diode $t_{rr}=95ns$ typ.
- $10\mu s$ Short Circuit Capability

Applications

- General Purpose Inverter

Specifications

Absolute Maximum Ratings at $T_a = 25^\circ C$, Unless otherwise specified

Parameter	Symbol	Value	Unit	
Collector to Emitter Voltage	V_{CES}	600	V	
Gate to Emitter Voltage	V_{GES}	± 20	V	
Collector Current (DC)	I_C *1	@ $T_c=25^\circ C$ *2	24	A
Limited by T_{jmax}		@ $T_c=100^\circ C$ *2	14	A
Collector Current (Peak)	I_{CP}	60	A	
Pulse width Limited by T_{jmax}				
Diode Average Output Current	I_O	15	A	
Power Dissipation	P_D	54	W	
$T_c=25^\circ C$ (Our ideal heat dissipation condition) *2				
Junction Temperature	T_J	175	$^\circ C$	
Storage Temperature	T_{stg}	-55 to +175	$^\circ C$	

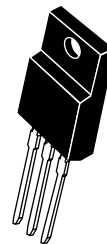
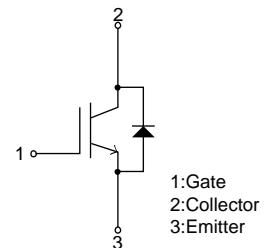
Note : *1 Collector Current is calculated from the following formula.

$$I_C(T_c) = \frac{T_{jmax} - T_c}{R_{th(j-c)} \times V_{CE(sat)}(I_C(T_c))}$$

*2 Our condition is radiation from backside.

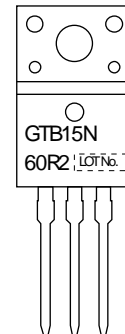
The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminum.

Electrical Connection N-Channel



TO-220F-3FS

Marking



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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Electrical Characteristics at Ta = 25°C, Unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit	
			min	typ	max		
Collector to Emitter Breakdown Voltage	V(BR)CES	IC=500μA, VGE=0V	600			V	
Collector to Emitter Cut off Current	ICES	VCE=600V, VGE=0V	Tc=25°C		10	μA	
			Tc=125°C		1	mA	
Gate to Emitter Leakage Current	IGES	VGE=±20V, VCE=0V			±100	nA	
Gate to Emitter Threshold Voltage	VGE(th)	VCE=20V, IC=250μA	4.5		7.0	V	
Collector to Emitter Saturation Voltage	VCE(sat)	VGE=15V, IC=15A		1.85	2.1	V	
		VGE=15V, IC=14A	Tc=100°C		2.0	2.3	V
Forward Diode Voltage	VF	IF=15A		1.7	2.1	V	
Input Capacitance	Cies	VCE=20V, f=1MHz		2000		pF	
Output Capacitance	Coes			65		pF	
Reverse Transfer Capacitance	Cres			50		pF	
Turn-ON Delay Time	t _{d(on)}			70		ns	
Rise Time	t _r	VCC=300V, IC=15A RG=30Ω, L=500μH VGE=0V/15V Vclamp=400V Tc=25°C See Fig.1, See Fig.2		40		ns	
Turn-ON Time	ton			200		ns	
Turn-OFF Delay Time	t _{d(off)}			190		ns	
Fall Time	t _f			75		ns	
Turn-OFF Time	toff			290		ns	
Turn-ON Energy	Eon			550		μJ	
Turn-OFF Energy	Eoff			220		μJ	
Total Gate Charge	Qg			80		nC	
Gate to Emitter Charge	Qge		VCE=300V, VGE=15V, IC=15A		16		nC
Gate to Collector "Miller" Charge	Qgc				38		nC
Diode Reverse Recovery Time	t _{rr}	IF=15A, di/dt=300A/μs, VCC=300V, See Fig.3		95		ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

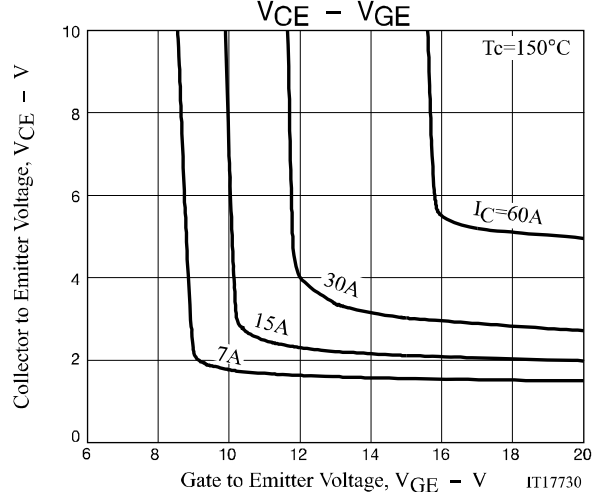
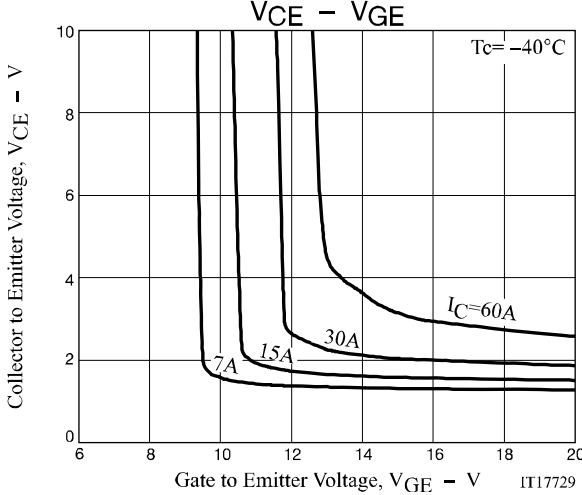
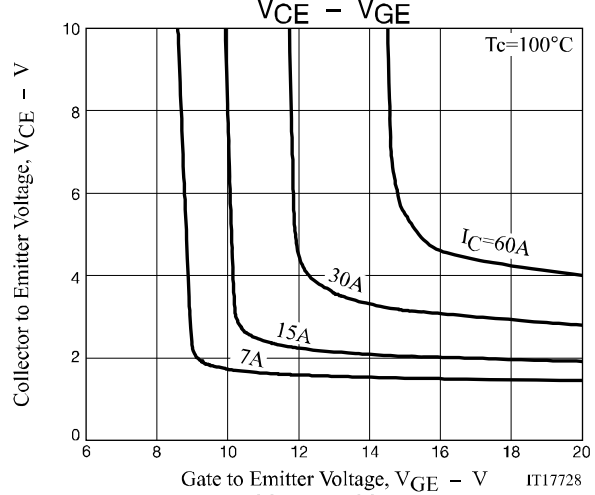
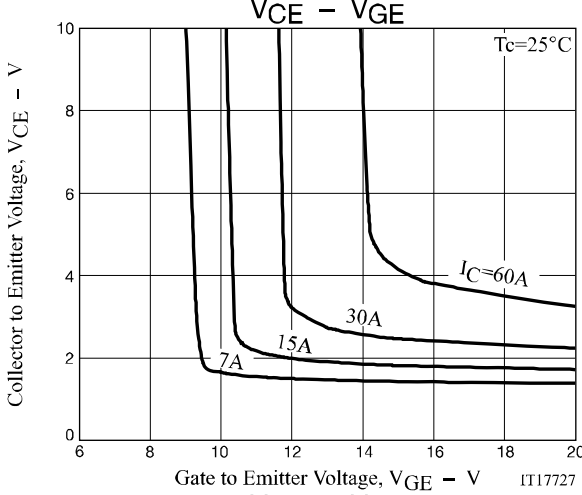
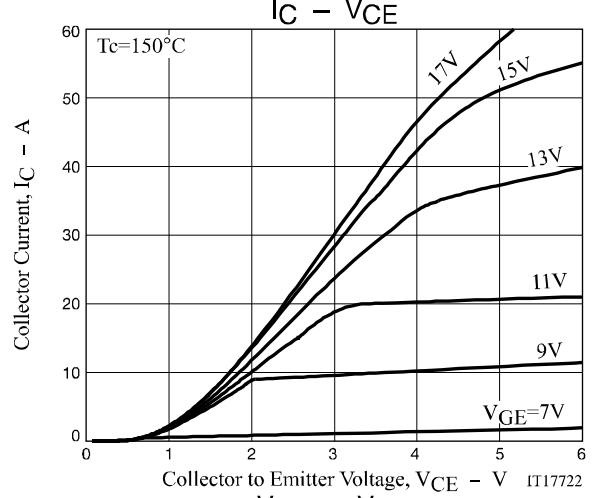
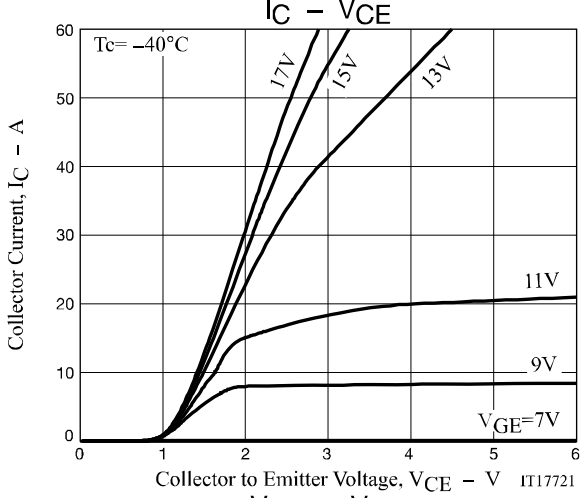
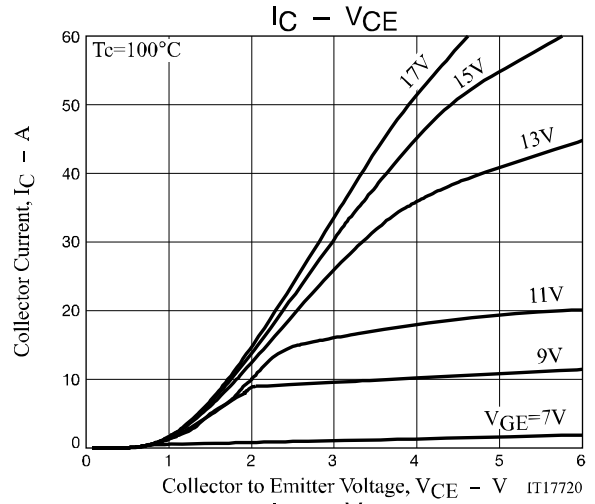
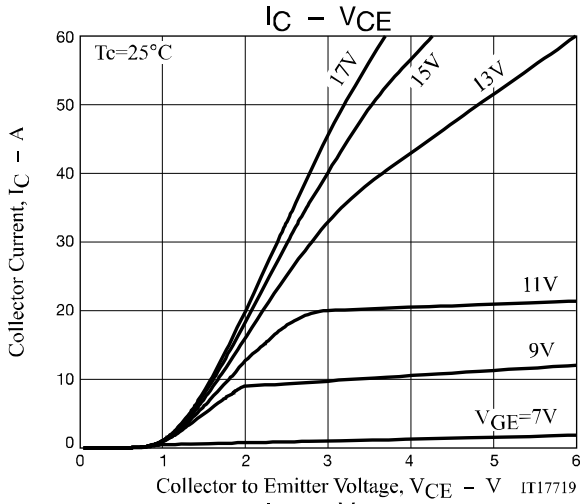
Thermal Characteristics at Ta = 25°C, Unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Thermal Resistance IGBT (Junction to Case)	Rth(j-c) (IGBT)	Tc=25°C (Our ideal heat dissipation condition) *2	2.78	°C/W
Thermal Resistance (Junction to Ambient)	Rth(j-a)		69	°C/W

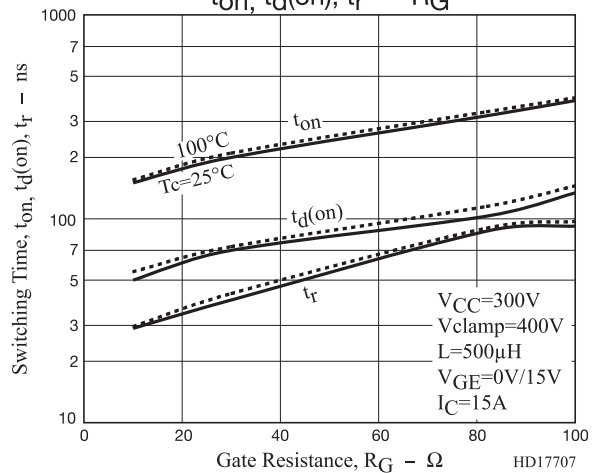
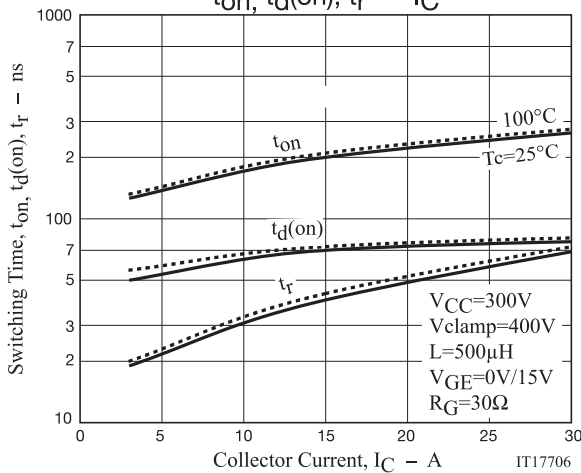
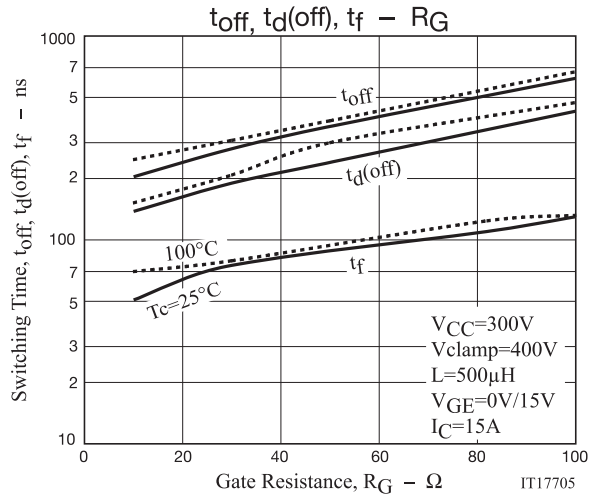
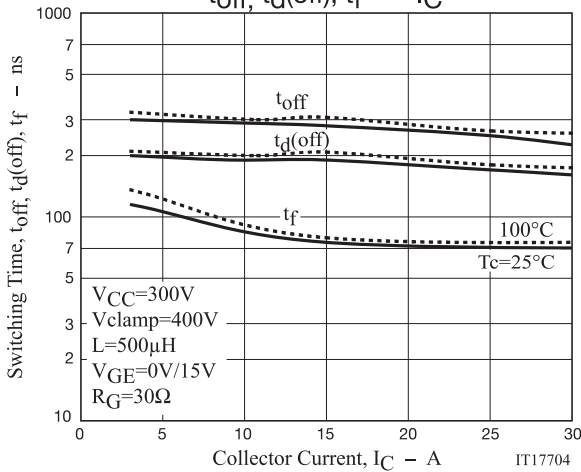
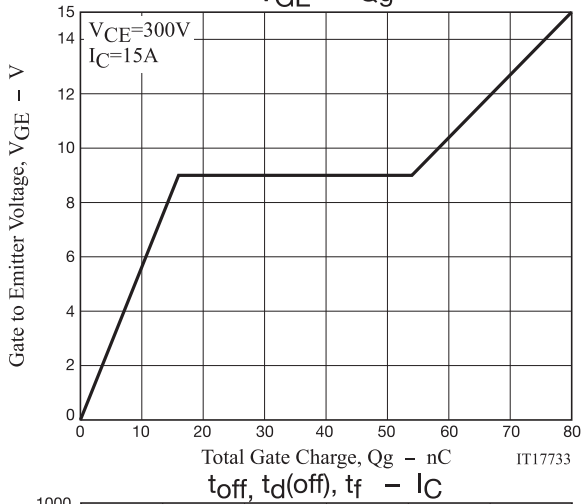
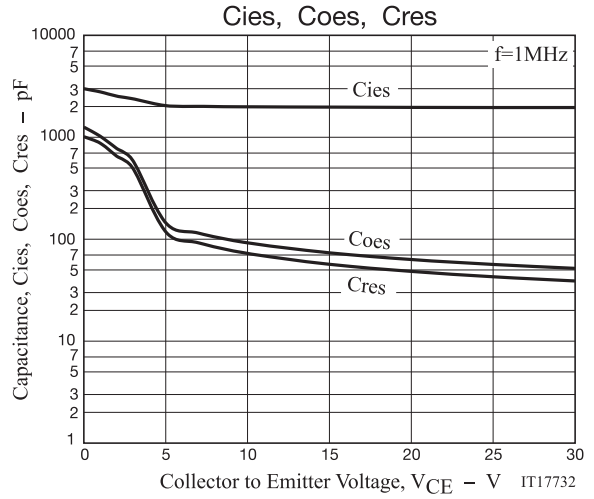
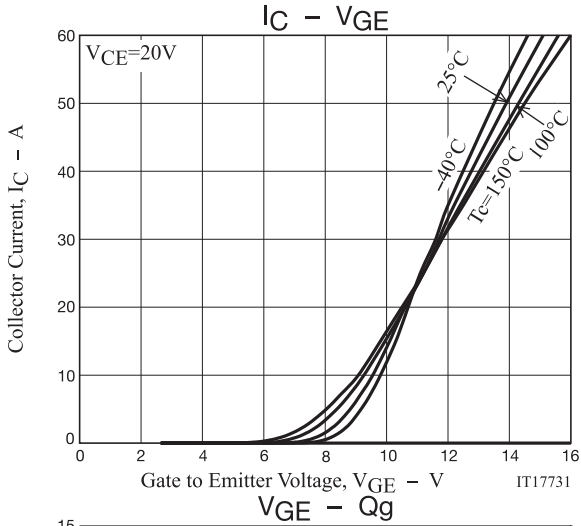
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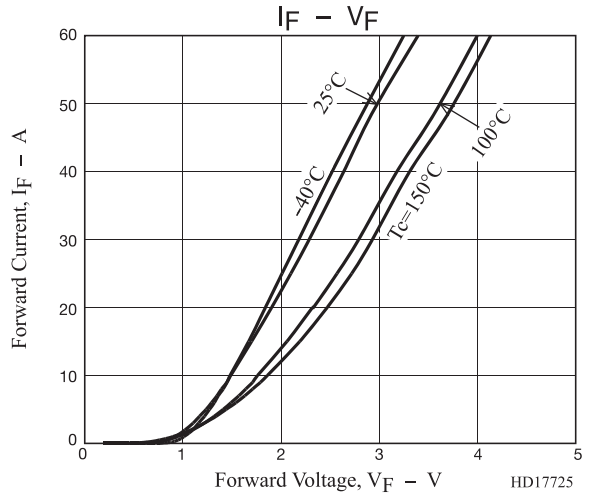
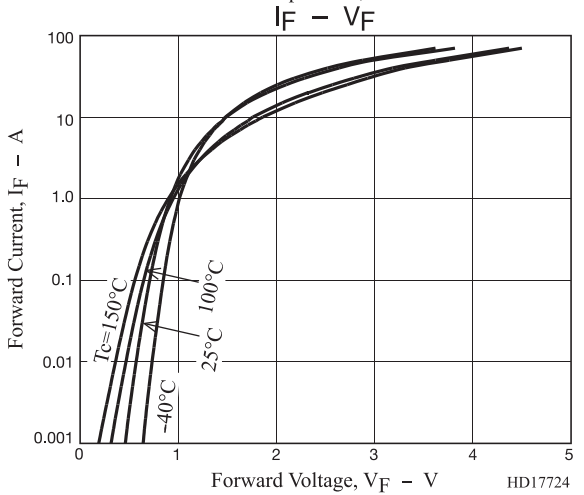
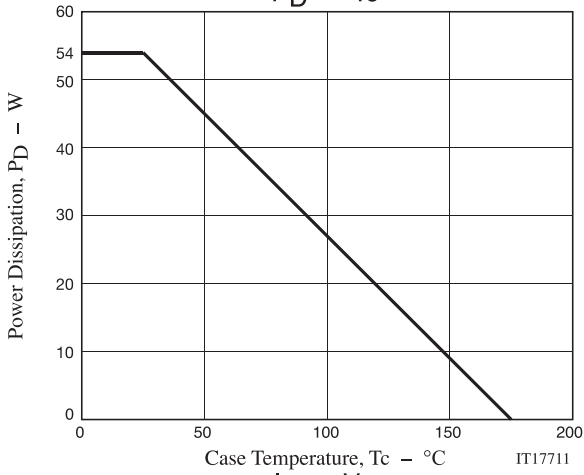
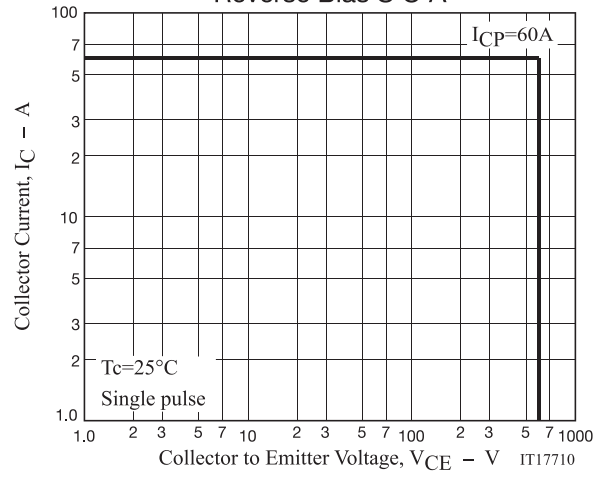
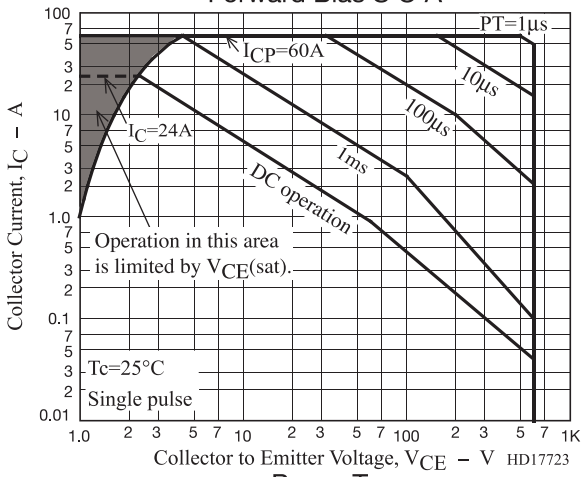
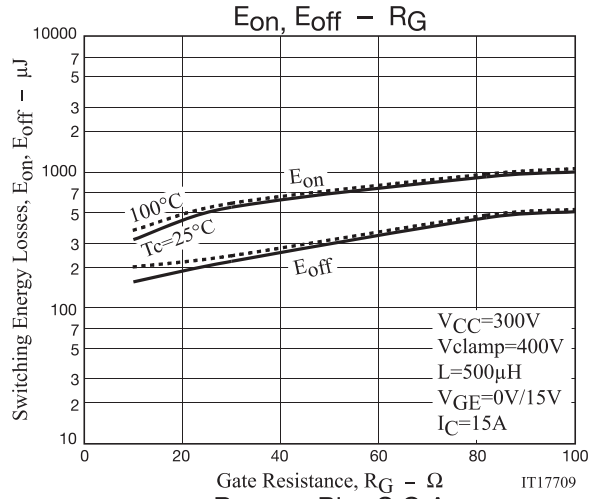
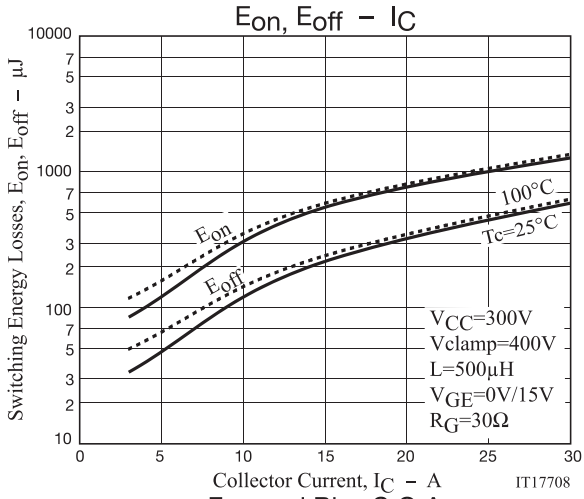
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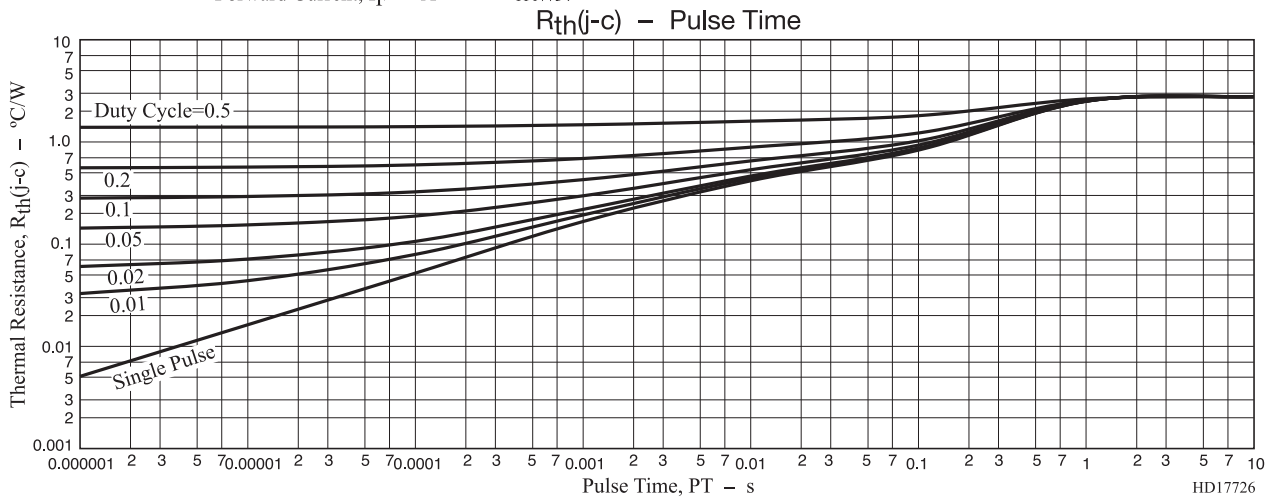
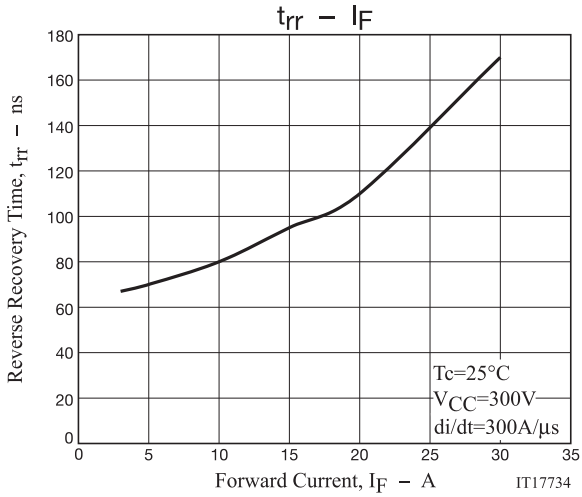


Fig.1 Switching Time Test Circuit

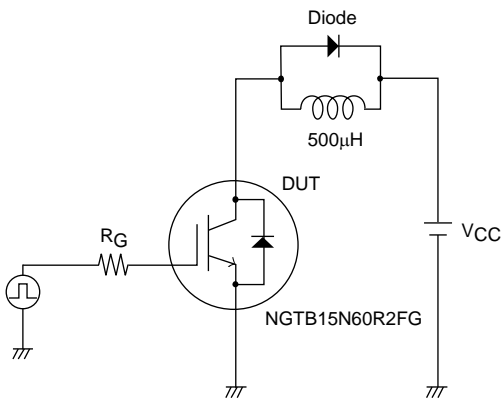


Fig.2 Timing Chart

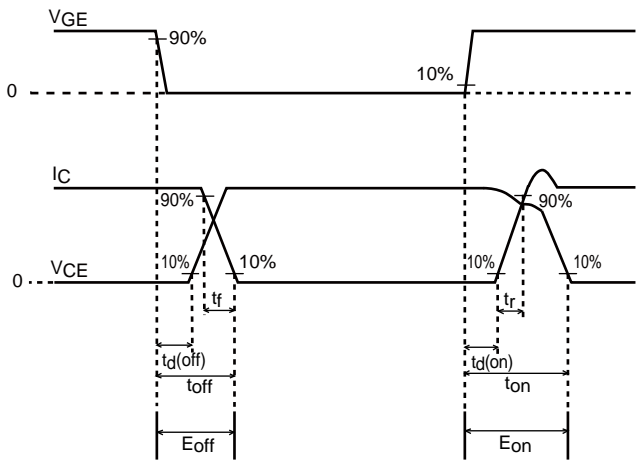
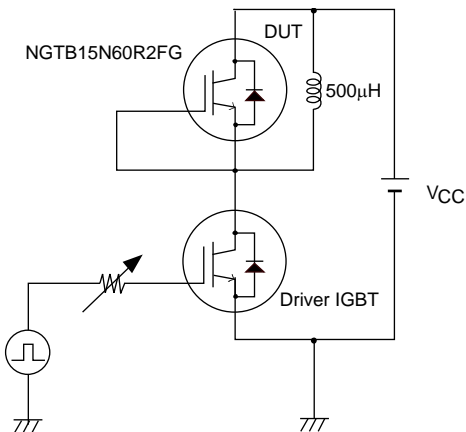


Fig.3 Reverse Recovery Time Test Circuit



Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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